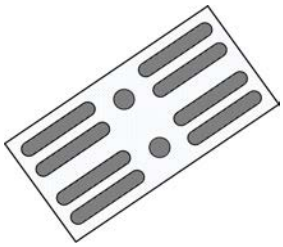
SZCJ Shenzhen Changji Semiconductor Co., LTD.

CSP Enhancement Mode Power MOSFET

CJ8208SP-A Dual N-Channel MOSFET

V_{SSS}	$R_{SS(on)}$TYP	I_S
12V	2.1mΩ@4.5V	14A
	2.2mΩ@3.8V	
	2.5mΩ@3.1V	
	2.9mΩ@2.5V	

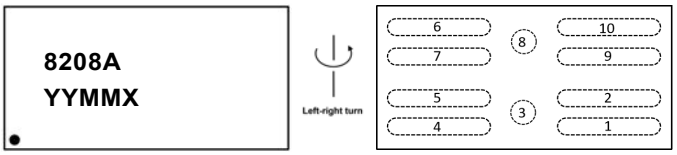
CSPC3015-10



DESCRIPTION

The CJ8208SP-A uses advanced trench technology to provide excellent $R_{SS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V while retaining a 8V $V_{GS(MAX)}$ rating. It is ESD protected. This device is suitable for use as a unidirectional or bi-directional load switch, facilitated by its common-drain configuration.

Marking and pin assignment

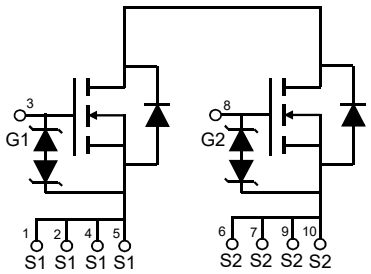


Top View Bottom View

Marking:
1. 8208A: Product Code
2. YYMMX: Date Code
3. Solid dot: Pin 1

1,2,4,5. Source1 3. Gate1
6,7,9,10. Source2 8. Gate2

Equivalent Circuit



ABSOLUTE MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Source to Source Voltage	V_{SSS}	12	V
Gate-Source Voltage	V_{GSS}	±8	V
Source Current(DC)	I_S ①	14	A
	I_S ②	29	A
Source Current (Pulsed)	I_{SP} ①③	140	A
Total Power Dissipation	P_T ①	1.7	W
	P_T ②	4.0	W
Channel Temperature	T_{ch}	150	℃
Storage Temperature Range	T_{STG}	-55 To 150	℃

MOSFET ELECTRICAL CHARACTERISTICS

T_a=25℃ unless otherwise specified

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Parameters						
Source to Source Breakdown Voltage	BV_{SSS}	I_S=1mA ,V_{GS}=0V	12			V
Zero-Gate Voltage Source Current	I_{SSS}	V_{SS}=12V,V_{GS}=0V			1	μA
Gate to Source Leakage Current	I_{GSS}	V_{SS}=0V, V_{GS}= ±8V			±10	μA
		V_{SS}=0V, V_{GS}= ±5V			±1	μA
Gate to Source Threshold Voltage	V_{TH}	V_{SS}=10V, I_S=1.11mA	0.35	0.8	1.4	V
Source to Source On-state Resistance	$R_{SS(on)}$	V_{GS}=4.5V,I_S=2A	1.0	2.1	2.8	mΩ
		V_{GS}=3.8V,I_S=2A	1.1	2.2	2.9	mΩ
		V_{GS}=3.1V,I_S=2A	1.3	2.5	4.0	mΩ
		V_{GS}=2.5V,I_S=2A	1.6	2.9	6.15	mΩ
Input Capacitance	C_{iss}	V_{SS}=10V,V_{GS}=0V, f=1kHz		3530		pF
Output Cpacitance	C_{oss}			855		pF
Reverse Transfer Capacitance	C_{rss}			741		pF
Turn-on Delay Time	$t_{d(on)}$ ④	V_{DD}=10V,R_L=2.5Ω V_{GS}=4.5V		1.92		μS
Turn-on Rise Time	t_r ④			3.70		μS
Turn-off Delay Time	$t_{d(off)}$ ④			16.6		μS
Turn-off Fall Time	t_f ④			11.2		μS
Total gate charge	Q_g ④	V_{SS}=10V,I_S=7A,V_{GS}=6V		59.7		nC
Gate1-source1 charge	Q_{g1s1} ④			33.1		nC
Gate1-source2 charge	Q_{g1s2} ④			15.5		nC
Diode Forward Voltage	$V_{F(S-S)}$ ⑤	V_{GS}=0V,I_S=2A			1.3	V

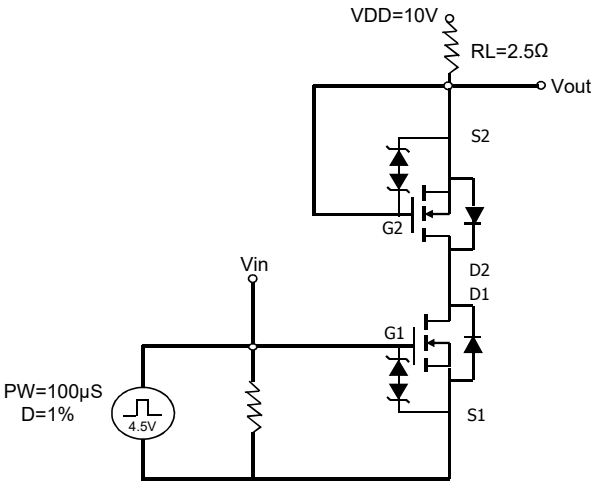
Notes: 1.Mounted on FR4 board (25.4mm×25.4mm×t1.0mm) using the minimum recommended pad size (36um Copper).

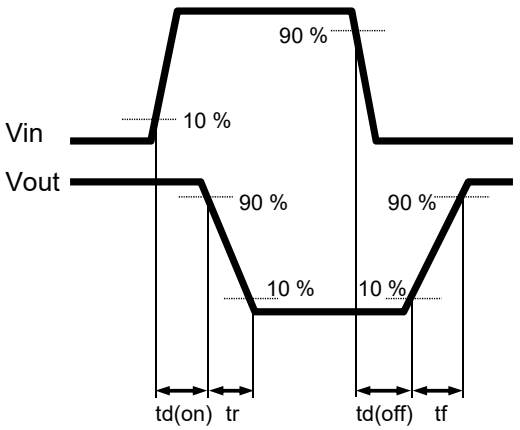
2.Mounted on Ceramic substrate(70mm×70mm×t1.0mm).

3.t = 10 ms , Duty Cycle = 1 %.

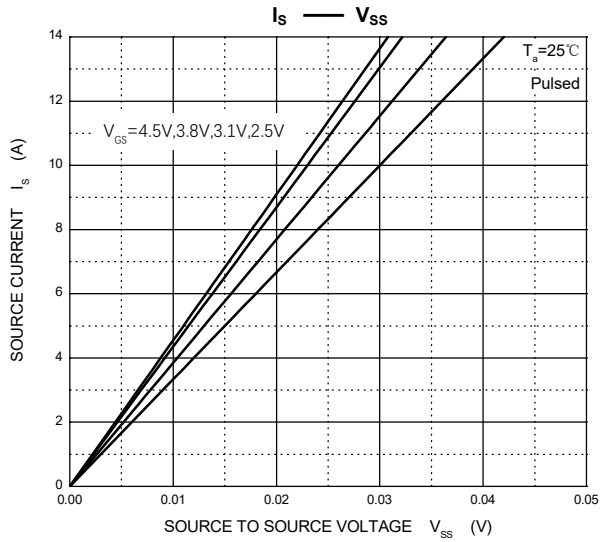
4.When FET1 is measured,G2 and S2 are short-circuited.

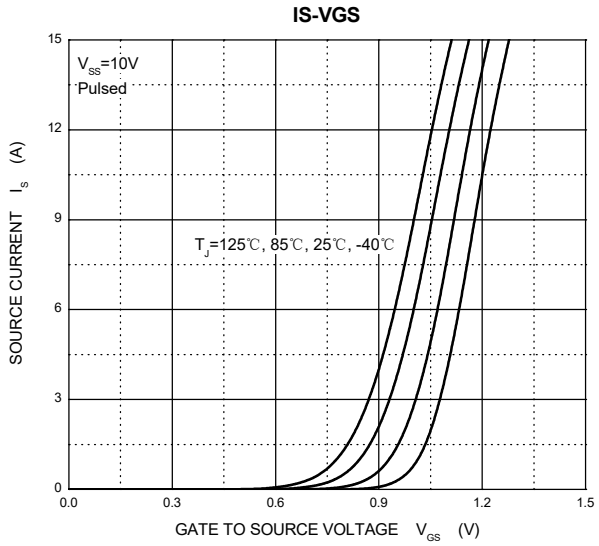
5.When FET1 is measured, FET2 is biased with V_{G2S2}=4.5V.

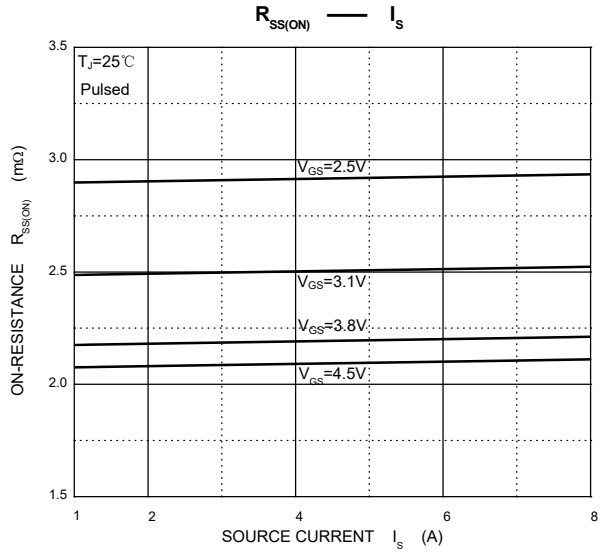


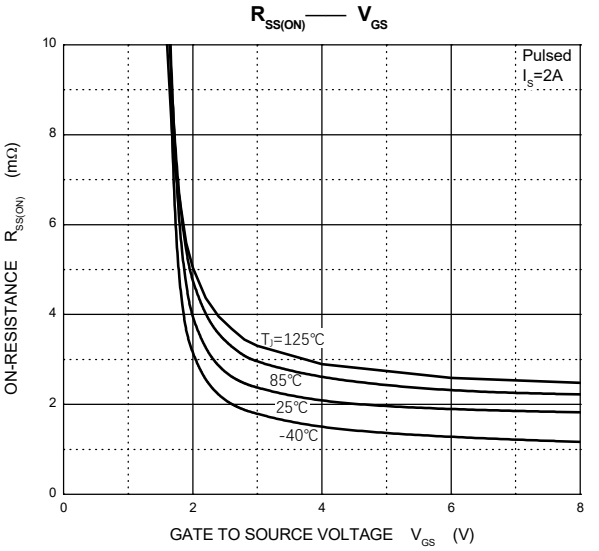


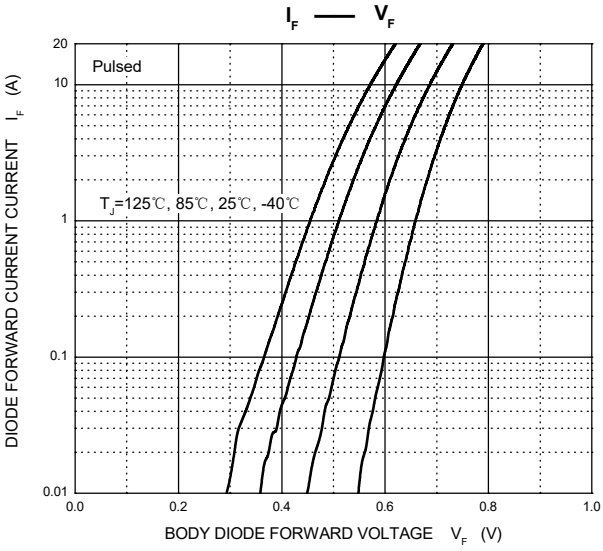
Typical Characteristics

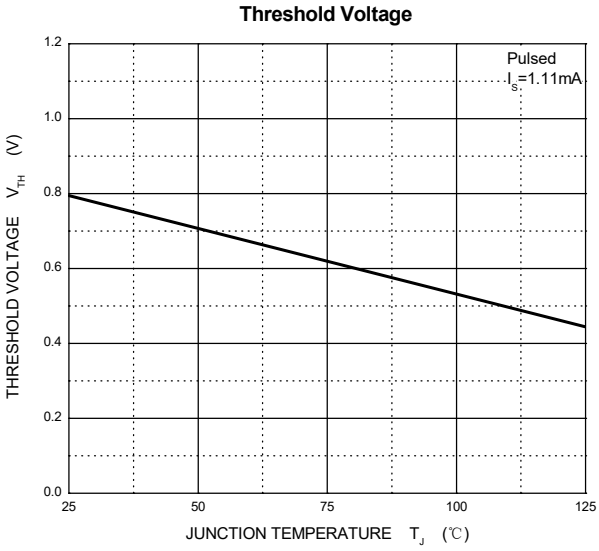






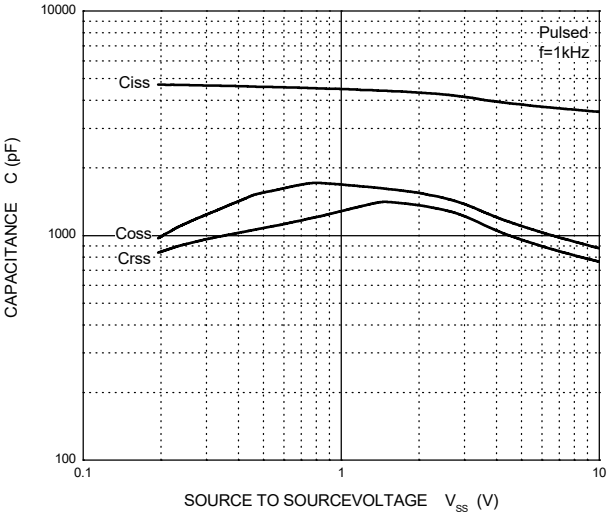




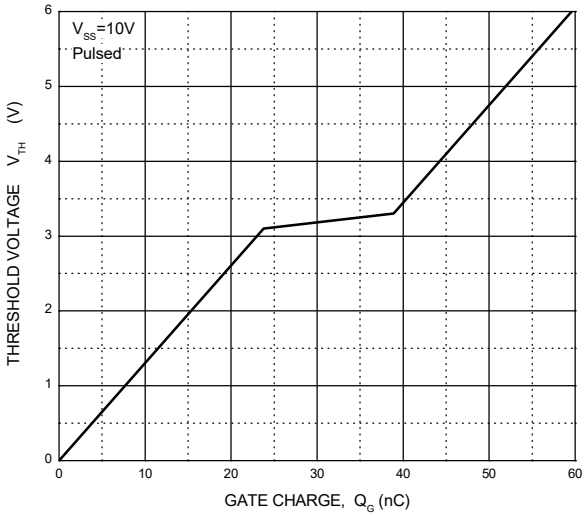


Typical Characteristics

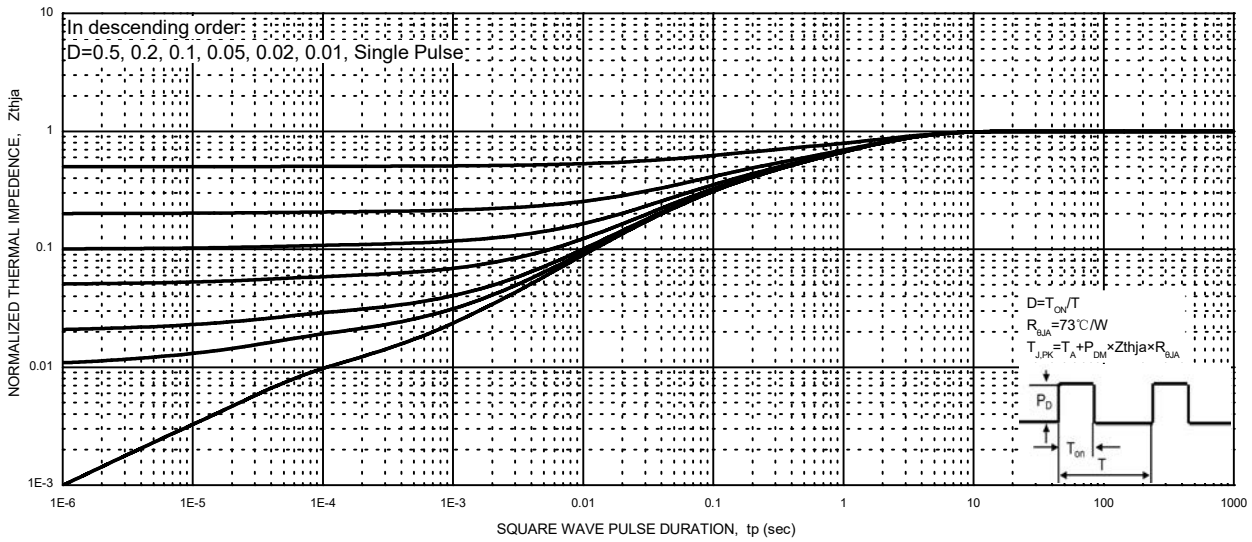
Capacitances



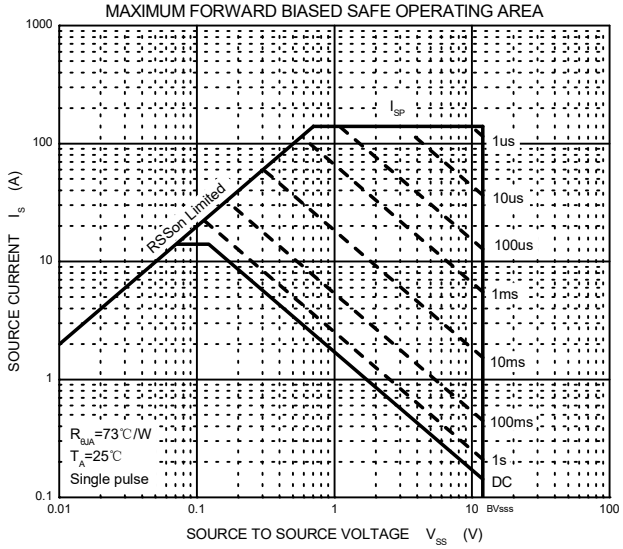
Gate Charge



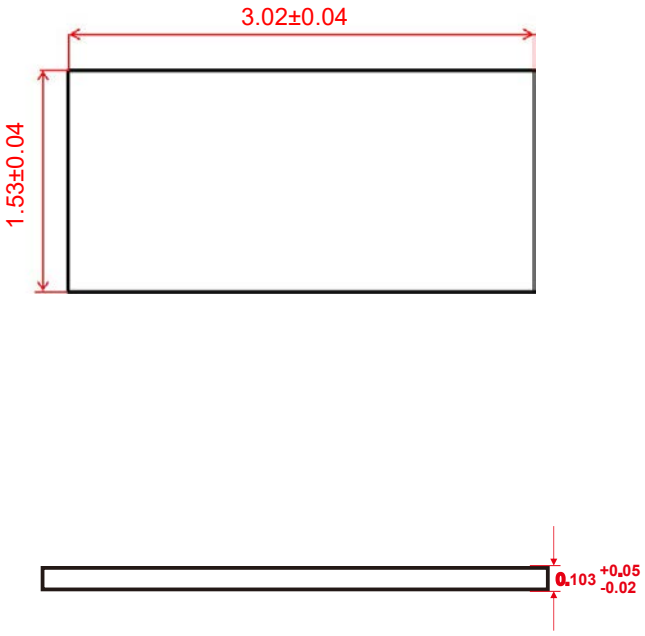
NORMALIZED TRAISIENT THERMAL IMPENDANCE



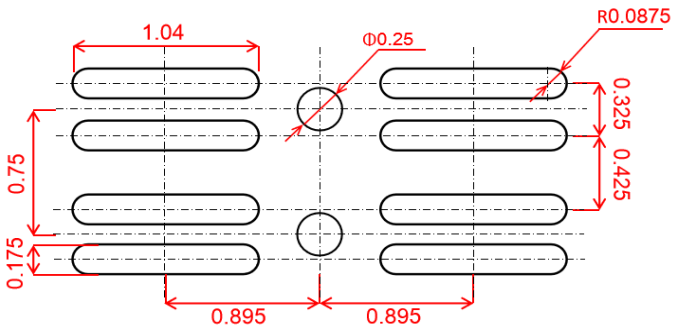
MAXIMUM FORWARD BIASED SAFE OPERATING AREA



CSPC3015-10 Package Outline Dimensions(Unit:mm)



CSPC3015-10 Suggested Pad Layout (Unit:mm)

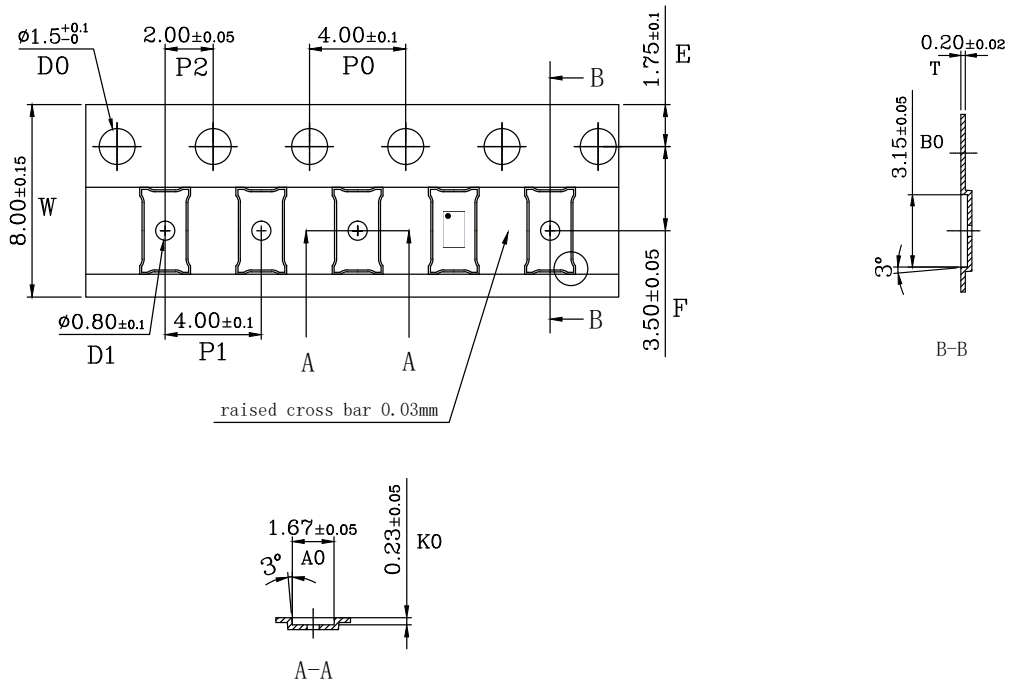


Note:
1.Controlling dimension:in millimeters.
2.General tolerance:± 0.050mm.
3.The pad layout is for reference purposes only.

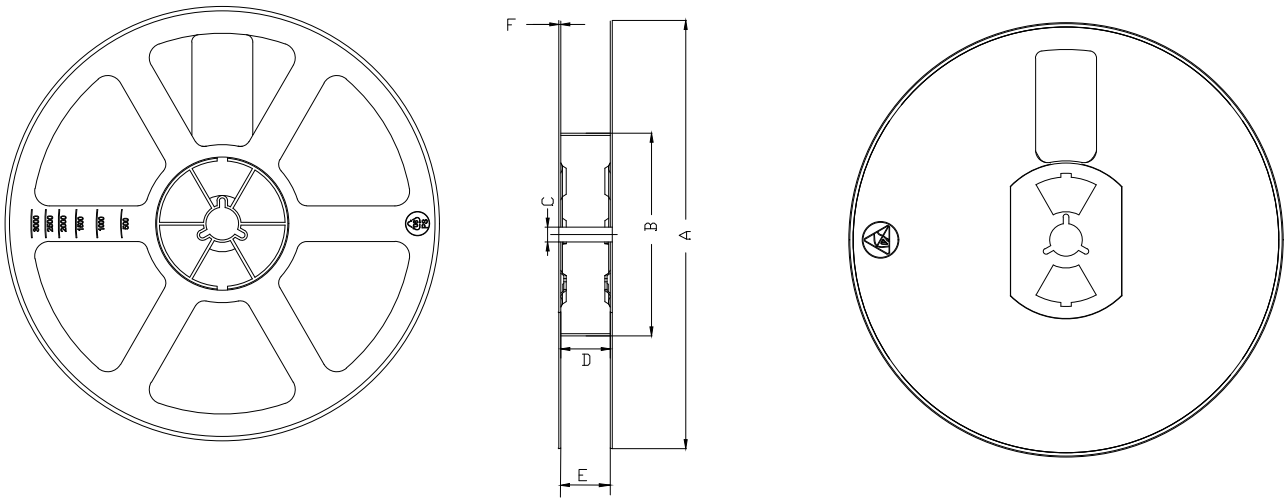
NOTICE

SZCJ reserves the rights to make modifications, enhancemen provements, corrections er changes without further notice to any product herein. SZCJ does not assume any liabilities arising out of the application or use of any product describe in.

Tape and Reel



产品尺寸规格 (UNIT:mm)						
规格	A0	B0	K0	P0	P1	P2
尺寸	1.67±0.05	3.15±0.05	0.23±0.05	4.0±0.1	4.0±0.1	2.0±0.05
规格	T	E	F	D0	D1	W
尺寸	0.2±0.02	1.75±0.1	3.5±0.05	$1.5^{+0.1}_{-0.0}$	0.80±0.1	8.0±0.15



SIZE	8MM
A	178±2.0
B	55±1.0
C	$13.0^{+0.35}_{-0.15}$
D	$8.4^{+2.5}_{-0.4}$
E	$8.65^{+4.7}_{-0.65}$
F	1.5±0.5

Attention:

1、When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.

2、The products described in this book are intended to be used for general applications (such as office equipment, communications equipment, measuring instruments and household appliances), or for specific applications as expressly stated in this book. Consult our sales staff in advance for information on the following applications: Special applications (such as for airplanes, aerospace, automotive equipment, traffic signaling equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body. It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the products described in this book for any special application, unless our company agrees to your using the products in this book for any special application.

3、Specifications of any and all SZCJ products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

4、You should use the SZCJ products described in this document within the range specified by SZCJ, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. SZCJ shall have no liability for malfunctions or damages arising out of the use of SZCJ products beyond such specified ranges.

5、Regarding monolithic semiconductors, if you should intend to use this IC continuously under high temperature, high current, high voltage, or drastic temperature change, even if it is used within the range of absolute maximum ratings or operating conditions, there is a possibility of decrease reliability. Please contact us for a confirmation.

6、SZCJ strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

7、No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of CHANGJI ELEC.TECH.

8、SZCJ has used reasonable care in preparing the information included in this document, but SZCJ does not warrant that such information is error free. SZCJ assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.

9、The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.

This catalog provides information as of Aug. 2022. Specifications and information herein are subject to change without notice.